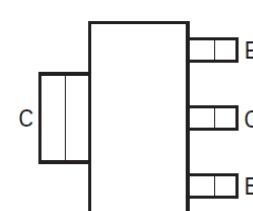
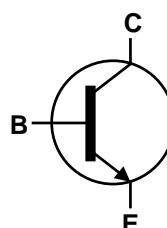


## Features

- $BV_{CEO} > 45V, 60V \& 80V$
- $I_C = 1A$  High Continuous Collector Current
- $I_{CM} = 2A$  Peak Pulse Current
- 2W Power Dissipation
- Low Saturation Voltage  $V_{CE(sat)} < 500mV @ 0.5A$
- Gain Groups 10 and 16
- Complementary PNP Types: BCP51, 52 and 53
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)



Top View



## Mechanical Data

- Case: SOT223
- Case Material: Molded Plastic. "Green" Molding Compound; UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208
- Weight: 0.112 grams (Approximate) (63)

## Applications

- Medium Power Switching or Amplification Applications
- AF Driver and Output Stages

## Ordering Information (Notes 4 & 5)

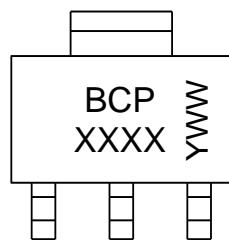
Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
BCP54TA	AEC-Q101	BCP 54	7	12	1,000
BCP5410TA	AEC-Q101	BCP 5410	7	12	1,000
BCP5416TA	AEC-Q101	BCP 5416	7	12	1,000
BCP5416QTA	Automotive	BCP 5416	7	12	1,000
BCP55TA	AEC-Q101	BCP 55	7	12	1,000
BCP5510TA	AEC-Q101	BCP 5510	7	12	1,000
BCP5516TA	AEC-Q101	BCP 5516	7	12	1,000
BCP56TA	AEC-Q101	BCP 56	7	12	1,000
BCP5610TA	AEC-Q101	BCP 5610	7	12	1,000
BCP5616TA	AEC-Q101	BCP 5616	7	12	1,000
BCP5616TC	AEC-Q101	BCP 5616	13	12	4,000
BCP5616QTA	Automotive	Refer to <a href="http://diodes.com/datasheets/BCP5616Q.pdf">http://diodes.com/datasheets/BCP5616Q.pdf</a>			
BCP5616QTC	Automotive	Refer to <a href="http://diodes.com/datasheets/BCP5616Q.pdf">http://diodes.com/datasheets/BCP5616Q.pdf</a>			

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to [http://www.diodes.com/quality/product\\_compliance\\_definitions/](http://www.diodes.com/quality/product_compliance_definitions/).
5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information

SOT223



BCP = Product Type Marking Code, Line 1  
 XXXX = Product Type Marking Code, Line 2 as follows:

BCP54 = 54  
 BCP5410 = 5410  
 BCP5416 = 5416

BCP55 = 55  
 BCP5510 = 5510  
 BCP5516 = 5516

BCP56 = 56  
 BCP5610 = 5610  
 BCP5616 = 5616

YWW = Date Code Marking  
 Y or  $\bar{Y}$  = Last Digit of Year (ex: 5= 2015)  
 WW or  $\bar{WW}$  = Week Code (01~53)

**Absolute Maximum Ratings** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	BCP54	BCP55	BCP56	Unit
Collector-Base Voltage	$V_{CBO}$	45	60	100	V
Collector-Emitter Voltage	$V_{CEO}$	45	60	80	V
Emitter-Base Voltage	$V_{EBO}$		5		V
Continuous Collector Current	$I_C$		1		A
Peak Pulse Collector Current	$I_{CM}$		2		A
Continuous Base Current	$I_B$		100		mA
Peak Pulse Base Current	$I_{BM}$		200		mA

**Thermal Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

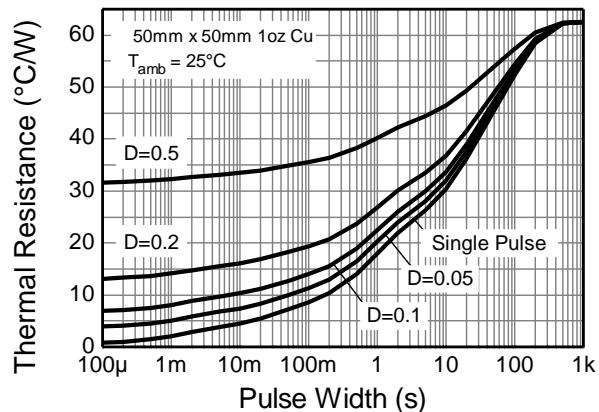
Characteristic	Symbol	Value	Unit
Power Dissipation	$P_D$	2	W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	62	°C/W
Thermal Resistance, Junction to Leads	$R_{\theta JL}$	19.4	°C/W
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to +150	°C

**ESD Ratings** (Note 8)

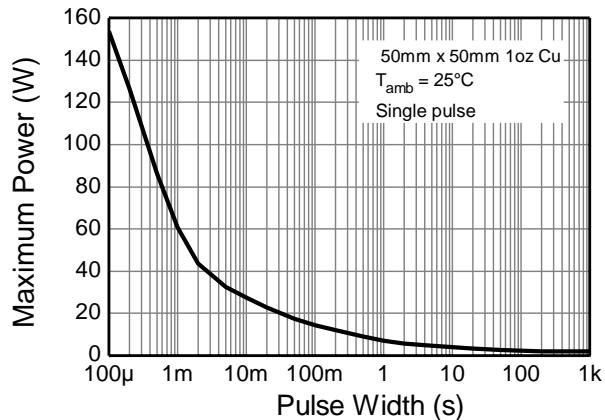
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	C

- Notes:
- 6. For a device mounted with the collector lead on 50mm x 50mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.
  - 7. Thermal resistance from junction to solder-point (at the end of the collector lead).
  - 8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

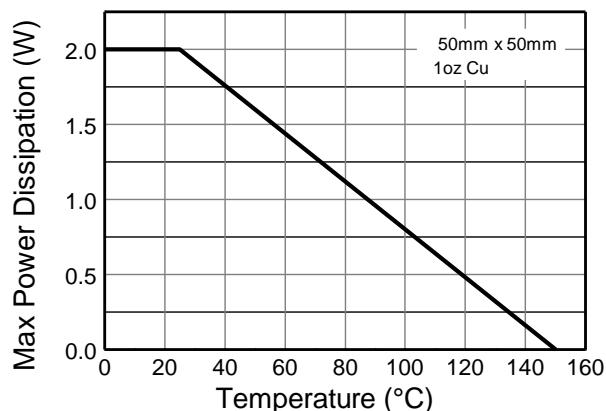
## Thermal Characteristics and Derating Information



**Transient Thermal Impedance**



**Pulse Power Dissipation**



**Derating Curve**

**Electrical Characteristics (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)**

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	$\text{BV}_{\text{CBO}}$	45	-	-	V	$I_C = 100\mu\text{A}$
		60				
		100				
Collector-Emitter Breakdown Voltage (Note 9)	$\text{BV}_{\text{CEO}}$	45	-	-	V	$I_C = 10\text{mA}$
		60				
		80				
Emitter-Base Breakdown Voltage	$\text{BV}_{\text{EBO}}$	5	-	-	V	$I_E = 10\mu\text{A}$
Collector Cut-Off Current	$I_{\text{CBO}}$	-	-	0.1 20	$\mu\text{A}$	$V_{\text{CB}} = 30\text{V}$ $V_{\text{CB}} = 30\text{V}, T_A = +150^\circ\text{C}$
Emitter Cut-Off Current	$I_{\text{EBO}}$	-	-	20	nA	$V_{\text{EB}} = 4\text{V}$
Static Forward Current Transfer Ratio (Note 9)	$h_{\text{FE}}$	25	-	-	-	$I_C = 5\text{mA}, V_{\text{CE}} = 2\text{V}$ $I_C = 150\text{mA}, V_{\text{CE}} = 2\text{V}$ $I_C = 500\text{mA}, V_{\text{CE}} = 2\text{V}$
		40	-	250		$I_C = 150\text{mA}, V_{\text{CE}} = 2\text{V}$
		25	-	-		$I_C = 150\text{mA}, V_{\text{CE}} = 2\text{V}$
		63	-	160	-	$I_C = 150\text{mA}, V_{\text{CE}} = 2\text{V}$
		100	-	250		$I_C = 150\text{mA}, V_{\text{CE}} = 2\text{V}$
Collector-Emitter Saturation Voltage (Note 9)	$V_{\text{CE}(\text{sat})}$	-	-	0.5	V	$I_C = 500\text{mA}, I_B = 50\text{mA}$
Base-Emitter Turn-On Voltage (Note 9)	$V_{\text{BE}(\text{on})}$	-	-	1.0	V	$I_C = 500\text{mA}, V_{\text{CE}} = 2\text{V}$
Transition Frequency	$f_T$	150	-	-	MHz	$I_C = 50\text{mA}, V_{\text{CE}} = 10\text{V}$ $f = 100\text{MHz}$
Output Capacitance	$C_{\text{obo}}$	-	-	25	pF	$V_{\text{CB}} = 10\text{V}, f = 1\text{MHz}$

Note: 9. Measured under pulsed conditions. Pulse width  $\leq 300\mu\text{s}$ . Duty cycle  $\leq 2\%$ .

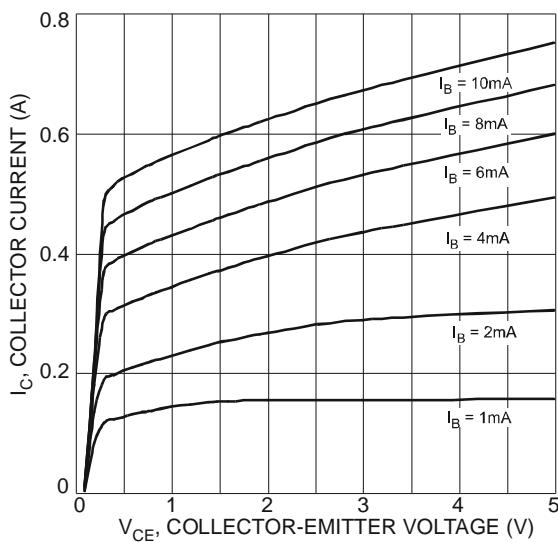


Fig. 1 Typical Collector Current vs. Collector-Emitter Voltage

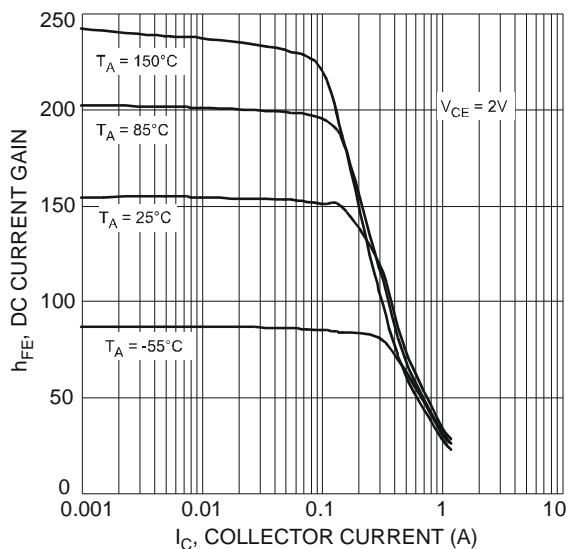


Fig. 2 Typical DC Current Gain vs. Collector Current

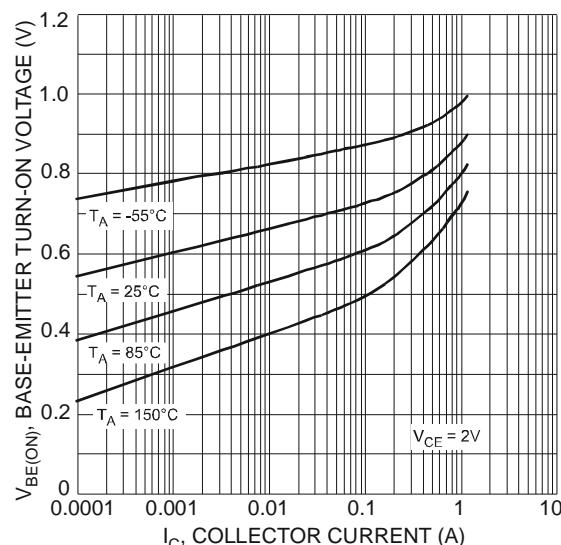


Fig. 3 Typical Base-Emitter Turn-On Voltage  
vs. Collector Current

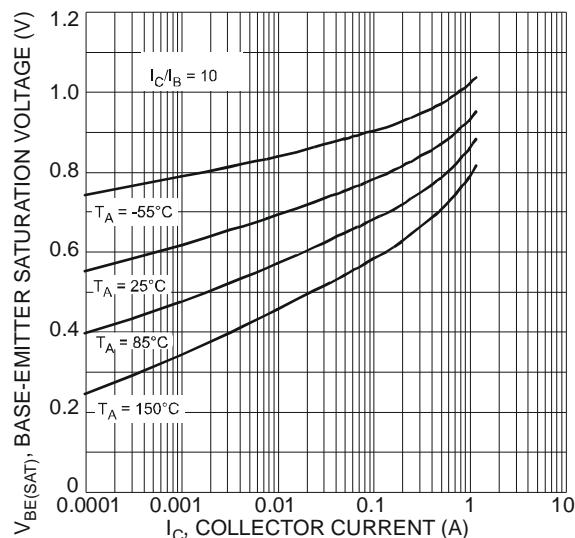


Fig. 5 Typical Base-Emitter Saturation Voltage  
vs. Collector Current

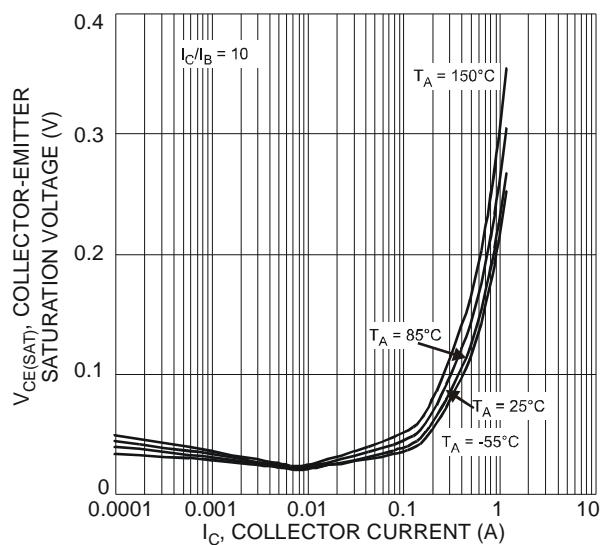


Fig. 4 Typical Collector-Emitter Saturation Voltage  
vs. Collector Current

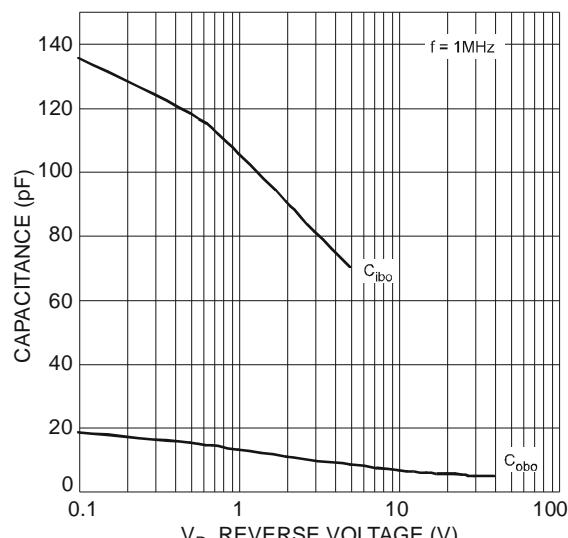


Fig. 6 Typical Capacitance Characteristics

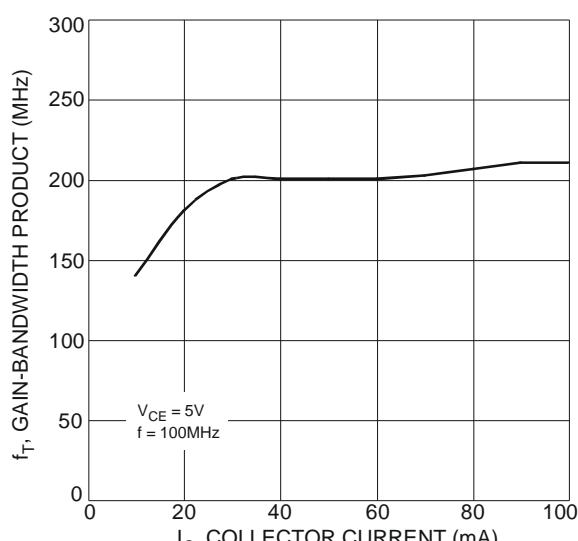
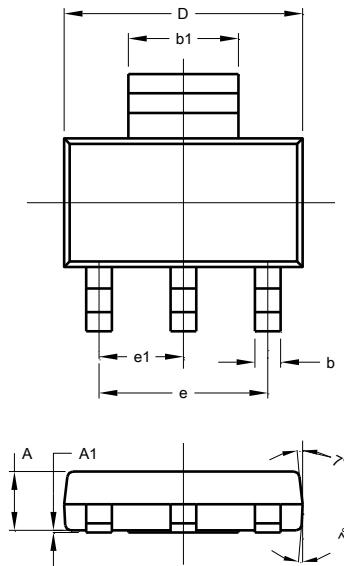


Fig. 7 Typical Gain-Bandwidth Product  
vs. Collector Current

## Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

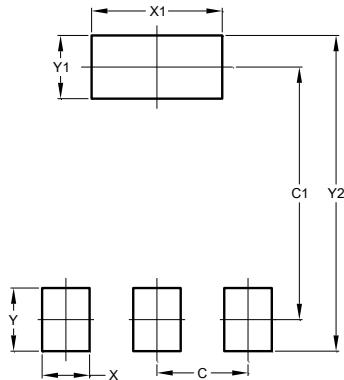


<b>SOT223</b>			
<b>Dim</b>	<b>Min</b>	<b>Max</b>	<b>Typ</b>
<b>A</b>	1.55	1.65	1.60
<b>A1</b>	0.010	0.15	0.05
<b>b</b>	0.60	0.80	0.70
<b>b1</b>	2.90	3.10	3.00
<b>C</b>	0.20	0.30	0.25
<b>D</b>	6.45	6.55	6.50
<b>E</b>	3.45	3.55	3.50
<b>E1</b>	6.90	7.10	7.00
<b>e</b>	-	-	4.60
<b>e1</b>	-	-	2.30
<b>L</b>	0.85	1.05	0.95
<b>Q</b>	0.84	0.94	0.89

All Dimensions in mm

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
<b>C</b>	2.30
<b>C1</b>	6.40
<b>X</b>	1.20
<b>X1</b>	3.30
<b>Y</b>	1.60
<b>Y1</b>	1.60
<b>Y2</b>	8.00

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